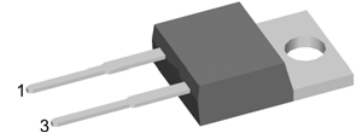
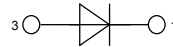


HiPerFRED²

High Performance Fast Recovery Diode
Low Loss and Soft Recovery
Single Diode

Part number

DPG 15 I 200 PA



Backside: cathode

Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low I_{rm}-values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{rm} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

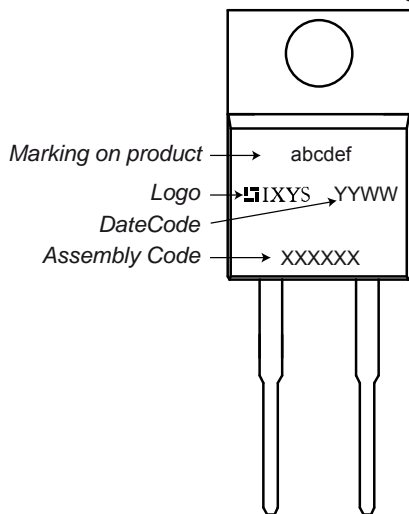
- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package:

- Housing: TO-220
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

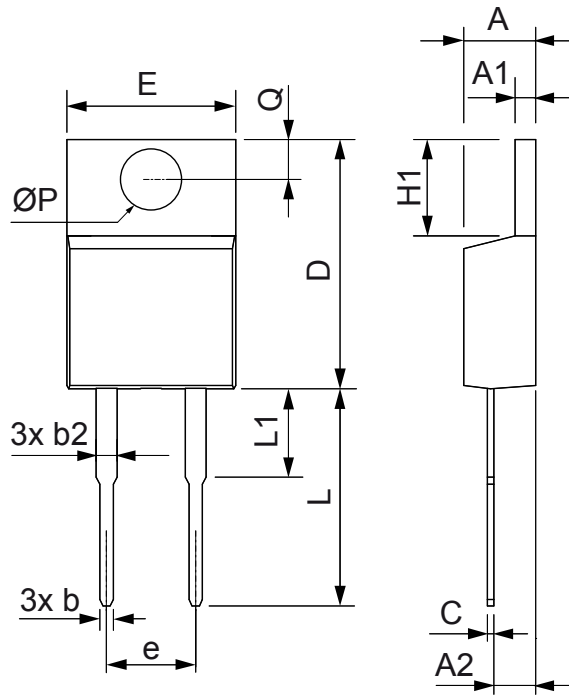
Symbol	Definition	Conditions	Ratings			Unit
			min.	typ.	max.	
V _{RRM}	max. repetitive reverse voltage				200	V
I _R	reverse current	V _R = 200 V			1	μA
		V _R = 200 V			0.08	mA
V _F	forward voltage	I _F = 15 A			1.26	V
		I _F = 30 A			1.51	V
		I _F = 15 A			1.01	V
		I _F = 30 A			1.29	V
I _{FAV}	average forward current	rectangular d = 0.5			15	A
V _{FO}	threshold voltage	} for power loss calculation only			0.69	V
r _F	slope resistance				18	mΩ
R _{thJC}	thermal resistance junction to case				1.70	K/W
T _{VJ}	virtual junction temperature		-55		175	°C
P _{tot}	total power dissipation				90	W
I _{FSM}	max. forward surge current	t = 10 ms (50 Hz), sine			240	A
I _{RM}	max. reverse recovery current				3	A
		I _F = 15 A; V _R = 130 V			6.5	A
t _{rr}	reverse recovery time	-di _F /dt = 200 A/μs			35	ns
					55	ns
C _J	junction capacitance	V _R = 150 V; f = 1 MHz			20	pF

Symbol	Definition	Conditions	Ratings			Unit
			min.	typ.	max.	
I_{RMS}	RMS current	per terminal			35	A
R_{thCH}	thermal resistance case to heatsink			0.50		K/W
T_{stg}	storage temperature		-55		150	°C
Weight				2		g
M_D	mounting torque		0.4		0.6	Nm
F_C	mounting force with clip		20		60	N

Product Marking

Part number

- D = Diode
- P = HiPerFRED
- G = extreme fast
- 15 = Current Rating [A]
- I = Single Diode
- 200 = Reverse Voltage [V]
- PA = TO-220AC (2)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DPG 15 I 200 PA	DPG15I200PA	Tube	50	506661

Outlines TO-220


Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.32	4.82	0.170	0.190
A1	1.14	1.39	0.045	0.055
A2	2.29	2.79	0.090	0.110
b	0.64	1.01	0.025	0.040
b2	1.15	1.65	0.045	0.065
C	0.35	0.56	0.014	0.022
D	14.73	16.00	0.580	0.630
E	9.91	10.66	0.390	0.420
e	5.08	BSC	0.200	BSC
H1	5.85	6.85	0.230	0.270
L	12.70	13.97	0.500	0.550
L1	2.79	5.84	0.110	0.230
$\varnothing P$	3.54	4.08	0.139	0.161
Q	2.54	3.18	0.100	0.125

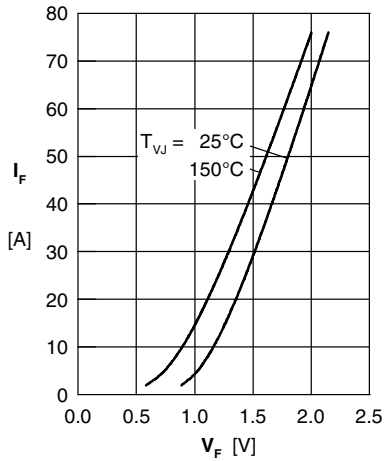


Fig. 1 Forward current I_F vs. V_F

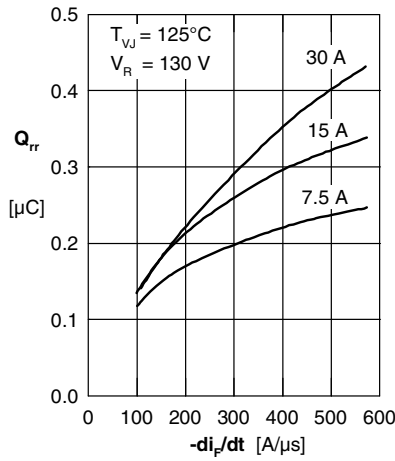


Fig. 2 Typ. reverse recovery charge Q_{rr} versus $-di_F/dt$

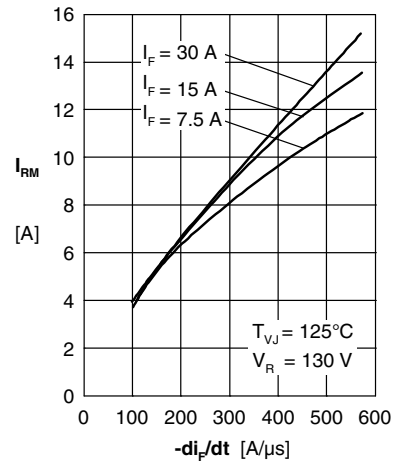


Fig. 3 Typ. peak reverse current I_{RM} versus $-di_F/dt$

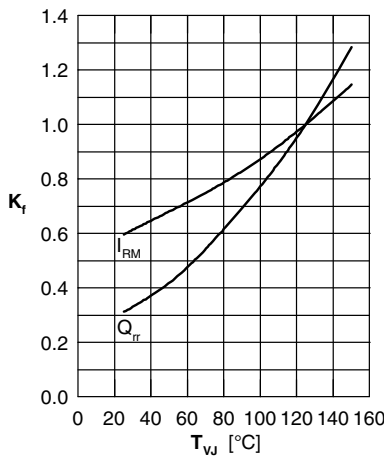


Fig. 4 Dynamic parameters Q_{rr} , I_{RM} versus T_{VJ}

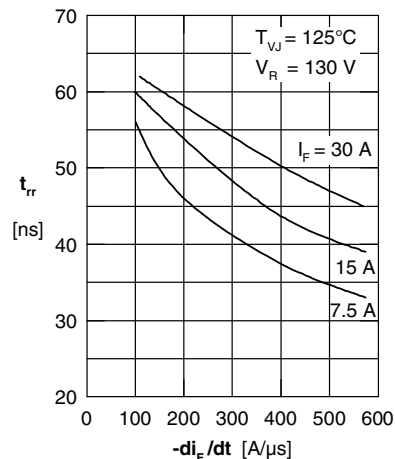


Fig. 5 Typ. recovery time t_{tr} vs. $-di_F/dt$

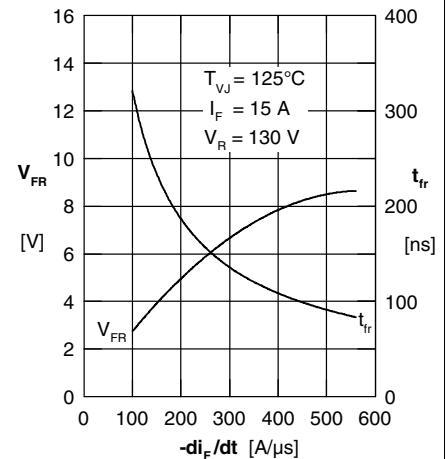


Fig. 6 Typ. peak forward voltage V_{FR} and t_{tr} versus di_F/dt

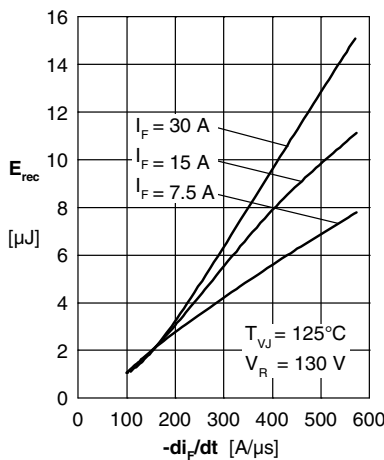


Fig. 7 Typ. recovery energy E_{rec} versus $-di_F/dt$

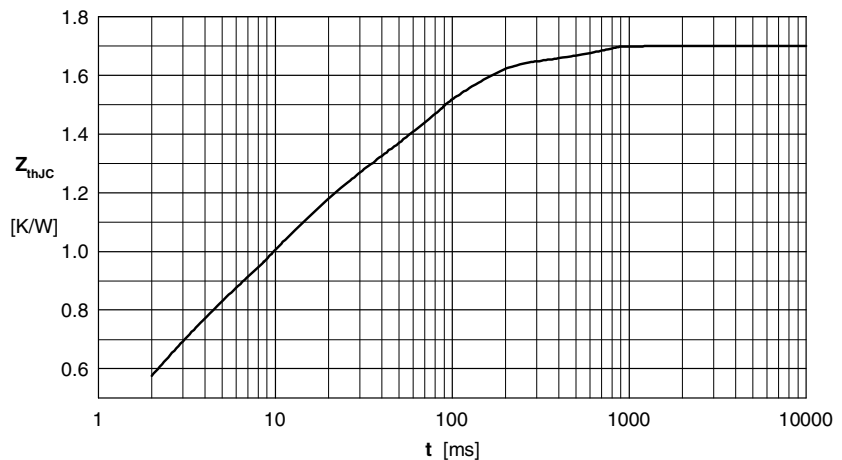


Fig. 8 Transient thermal resistance junction to case